

# Phase Control Disc Thyristor Type DT40-320-65

High power cycling capability / Low on-state and switching losses  
Designed for traction and industrial applications

Mean on-state current	$I_{TAV}$	320 A
Repetitive peak off-state voltage	$V_{DRM}$	4600 ÷ 6500 V
Repetitive peak reverse voltage	$V_{RRM}$	
Turn-off time	$t_q$	800 $\mu$ s
$V_{DRM}, V_{RRM}, V$	4600 4800 5000 5200 5400 5600 5800 6000 6200 6400 6500	
Voltage code	46 48 50 52 54 56 58 60 62 64 65	
$T_j, ^\circ C$		-60 ÷ 125

## MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	320 359 293	$T_c=79^\circ C$ ; Double side cooled; $T_c=70^\circ C$ ; Double side cooled; $T_c=85^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	502	$T_c=79^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz	
$I_{TSM}$	Surge on-state current	kA	4.0 4.5	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			4.0 4.5	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I^2t$	Safety factor	$A^2s \cdot 10^3$	80 100	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			60 80	$T_j=T_{j\max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	4600 ÷ 6500	$T_{j\min} < T_j < T_{j\max}$ ; 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	4700 ÷ 6600	$T_{j\min} < T_j < T_{j\max}$ ; 180° half-sine wave; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	0.6 $\cdot V_{DRM}$ 0.6 $\cdot V_{RRM}$	$T_j=T_{j\max}$ ; Gate open	

TRIGGERING				
I <sub>FGM</sub>	Peak forward gate current	A	8	T <sub>j</sub> =T <sub>j max</sub>
V <sub>RGM</sub>	Peak reverse gate voltage	V	5	
P <sub>G</sub>	Gate power dissipation	W	4	T <sub>j</sub> =T <sub>j max</sub> for DC gate current
SWITCHING				
(di <sub>T</sub> /dt) <sub>crit</sub>	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/μs	500	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =0.67·V <sub>DRM</sub> ; I <sub>TM</sub> =1400 A; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt≥2 A/μs
THERMAL				
T <sub>stg</sub>	Storage temperature	°C	-60÷50	
T <sub>j</sub>	Operating junction temperature	°C	-60÷125	
MECHANICAL				
F	Mounting force	kN	14.0 ÷ 16.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped
CHARACTERISTICS				
Symbols and parameters		Units	Values	Conditions
ON-STATE				
V <sub>TM</sub>	Peak on-state voltage, max	V	2.60	T <sub>j</sub> =25 °C; I <sub>TM</sub> =785 A
V <sub>T(TO)</sub>	On-state threshold voltage, max	V	1.338	T <sub>j</sub> =T <sub>j max</sub> ;
r <sub>T</sub>	On-state slope resistance, max	mΩ	2.351	0.5 π I <sub>TAV</sub> < I <sub>T</sub> < 1.5 π I <sub>TAV</sub>
I <sub>L</sub>	Latching current, max	mA	700	T <sub>j</sub> =25 °C; V <sub>D</sub> =12 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt≥1 A/μs
I <sub>H</sub>	Holding current, max	mA	300	T <sub>j</sub> =25 °C; V <sub>D</sub> =12 V; Gate open
BLOCKING				
I <sub>DRM</sub> , I <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =V <sub>DRM</sub> , V <sub>R</sub> =V <sub>RRM</sub>
(dv <sub>D</sub> /dt) <sub>crit</sub>	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/μs	1000, 1600, 2000, 2500	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =0.67·V <sub>DRM</sub> ; Gate open
TRIGGERING				
V <sub>GT</sub>	Gate trigger direct voltage, max	V	3.00 2.50 1.50	T <sub>j</sub> = T <sub>j min</sub> T <sub>j</sub> =25 °C T <sub>j</sub> = T <sub>j max</sub>
I <sub>GT</sub>	Gate trigger direct current, max	mA	400 250 150	T <sub>j</sub> = T <sub>j min</sub> T <sub>j</sub> = 25 °C T <sub>j</sub> = T <sub>j max</sub>
V <sub>GD</sub>	Gate non-trigger direct voltage, min	V	0.25	T <sub>j</sub> =T <sub>j max</sub> ;
I <sub>GD</sub>	Gate non-trigger direct current, min	mA	35.00	V <sub>D</sub> =0.67·V <sub>DRM</sub> ; Direct gate current
SWITCHING				
t <sub>gd</sub>	Delay time, max	μs	3.00	T <sub>j</sub> =25 °C; V <sub>D</sub> =1500 V; I <sub>TM</sub> =I <sub>TAV</sub> ; di/dt=200 A/μs;
t <sub>gt</sub>	Turn-on time, max	μs	10.00	Gate pulse: I <sub>G</sub> =2 A; V <sub>G</sub> =20 V; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt=2 A/μs
t <sub>q</sub>	Turn-off time <sup>2)</sup> , max	μs	800	dv <sub>D</sub> /dt=50 V/μs; T <sub>j</sub> =T <sub>j max</sub> ; I <sub>TM</sub> = I <sub>TAV</sub> ; di <sub>R</sub> /dt=-10 A/μs; V <sub>R</sub> =100V; V <sub>D</sub> =2000 V
Q <sub>rr</sub>	Total recovered charge, max	μC	2600	T <sub>j</sub> =T <sub>j max</sub> ; I <sub>TM</sub> = 1000 A;
t <sub>rr</sub>	Reverse recovery time, max	μs	52	di <sub>R</sub> /dt=-5 A/μs;
I <sub>rrM</sub>	Peak reverse recovery current, max	A	100	V <sub>R</sub> =100 V

THERMAL					
$R_{thjc}$	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0450	Direct current	Double side cooled
$R_{thjc-A}$			0.0990		Anode side cooled
$R_{thjc-K}$			0.0810		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0075	Direct current	

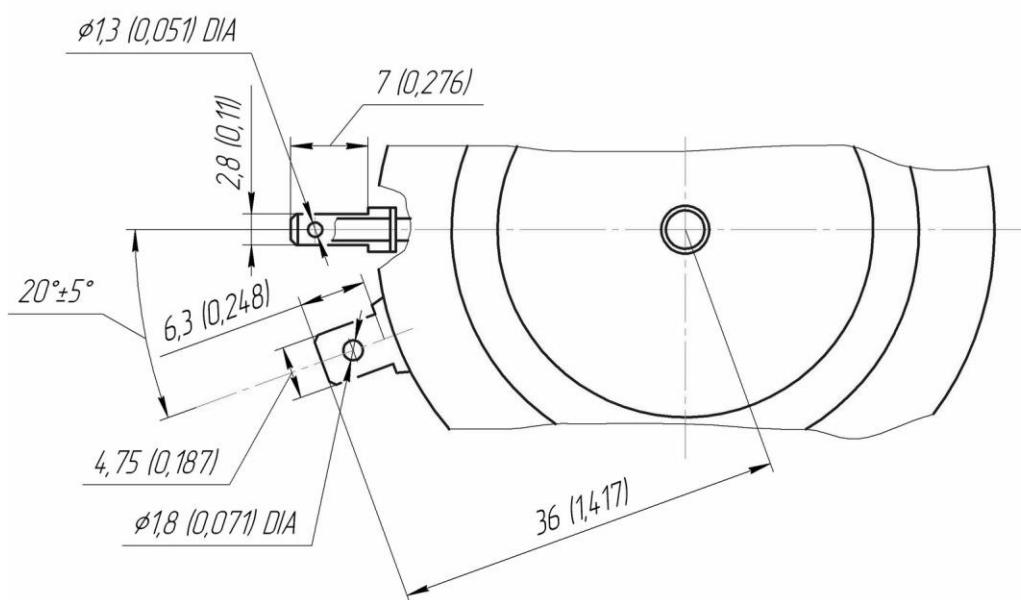
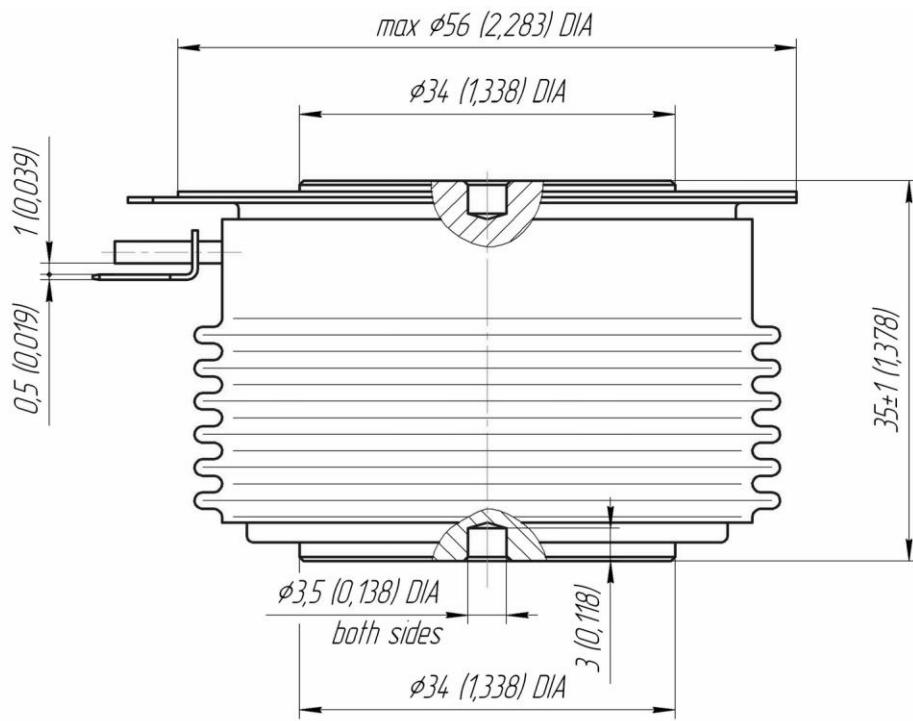
MECHANICAL					
w	Weight, max	g	400		
$D_s$	Surface creepage distance	mm (inch)	38.00 (1.496)		
$D_a$	Air strike distance	mm (inch)	21.00 (0.827)		

PART NUMBERING GUIDE						NOTES														
DT	40	320	65	7	0															
1	2	3	4	5	6															
1. DT - Phase Control Disc Thyristor						1) Critical rate of rise of off-state voltage														
2. Element Diameter						<table border="1"> <tr> <td>Symbol of Group</td> <td>7</td> <td>8</td> <td>8,5</td> <td>9</td> </tr> <tr> <td><math>(dv_D/dt)_{crit}, \text{V}/\mu\text{s}</math></td> <td>1000</td> <td>1600</td> <td>2000</td> <td>2500</td> </tr> </table>					Symbol of Group	7	8	8,5	9	$(dv_D/dt)_{crit}, \text{V}/\mu\text{s}$	1000	1600	2000	2500
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3. Mean on-state current, A						2) Turn-off time ( $dv_D/dt=50 \text{ V}/\mu\text{s}$ )														
4. Voltage code						<table border="1"> <tr> <td>Symbol of Group</td> <td>0</td> </tr> <tr> <td><math>t_{off}, \mu\text{s}</math></td> <td>800</td> </tr> </table>					Symbol of Group	0	$t_{off}, \mu\text{s}$	800						
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$t_{off}, \mu\text{s}$	800																			
5. Critical rate of rise of on-state current non-repetitive, V/ $\mu\text{s}$																				
6. Turn-off time ( $dv_D/dt=50 \text{ V}/\mu\text{s}$ )																				

## OVERALL DIMENSIONS

Package type: T.C5



All dimensions in millimeters (inches)